

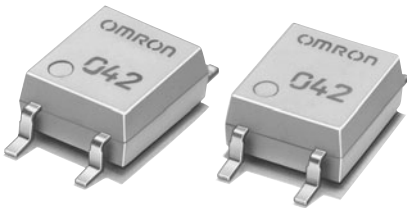
G3VM-41GR4

MOS FET Relays

MOS FET Relays with Low Output Capacitance and ON Resistance ($C \times R = 10\text{pF} \cdot \Omega$) in a 40-V Load Voltage Model.

- ON resistance of $2\ \Omega$ (typical) suppresses output signal attenuation.
- Leakage current of $1.0\ \text{nA}$ max. when output relay is open.

RoHS compliant

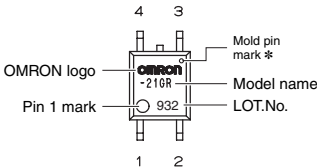
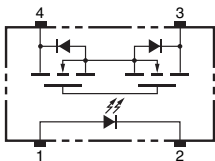


Note: The actual product is marked differently from the image shown here.

■ Application Examples

- Semiconductor test equipment
 - Test & Measurement equipment
 - Communication equipment
 - Data loggers

■ Terminal Arrangement/Internal Connections



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* The indentation in the corner diagonally opposite from the pin 1 mark is from a pin on the mold.

■ List of Models

Package type	Contact form	Terminals	Load voltage (peak value) *	Model	Minimum package quantity	
					Number per tube	Number per tape and reel
SOP4	1a (SPST-NO)	Surface-mounting Terminals	40 V	G3VM-41GR4	100	-
				G3VM-41GR4 (TR)	-	2,500

* The AC peak and DC value are given for the load voltage.

■ Absolute Maximum Ratings (Ta = 25°C)

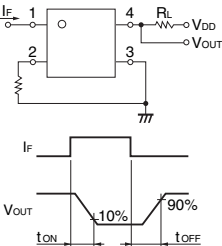
Item		Symbol	Rating	Unit	Measurement conditions
Input	LED forward current	IF	50	mA	Ta ≥ 25°C
	LED forward current reduction rate	ΔIF/°C	−0.5	mA/°C	
	LED reverse voltage	VR	5	V	
	Connection temperature	TJ	125	°C	
Output	Load voltage (AC peak/DC)	VOFF	40	V	Ta ≥ 25°C
	Continuous load current (AC peak/DC)	IO	250	mA	
	ON current reduction rate	ΔIO/°C	−2.5	mA/°C	
	Connection temperature	TJ	125	°C	
Dielectric strength between I/O (See note 1.)		VI-O	1500	Vrms	AC for 1 min
Ambient operating temperature		Ta	−20 to +85	°C	With no icing or condensation
Ambient storage temperature		Tstg	−55 to +125	°C	With no icing or condensation
Soldering temperature		-	260	°C	10 s

Note: 1. The dielectric strength between the input and output was checked by applying voltage between all pins as a group on the LED side and all pins as a group on the light-receiving side.

■ Electrical Characteristics (Ta = 25°C)

Item		Symbol	Minimum	Typical	Maximum	Unit	Measurement conditions
Input	LED forward voltage	VF	1.0	1.15	1.3	V	IF = 10 mA
	Reverse current	IR	-	-	10	μA	VR = 5 V
	Capacity between terminals	CT	-	15	-	pF	V = 0, f = 1 MHz
	Trigger LED forward current	IFT	-	-	4	mA	IO = 100 mA
Output	Maximum resistance with output ON	RON	-	2.0	3.0	Ω	IF = 5 mA, IO = 250 mA, t < 1 s
	Current leakage when the relay is open	ILEAK	-	-	1.0	nA	VOFF = 30 V, Ta = 50 °C
	Capacity between terminals	COFF	-	5	7	pF	V = 0, f = 100 MHz, t < 1 s
	Capacity between I/O terminals	CI-O	-	0.8	-	pF	f = 1 MHz, Vs = 0 V
Insulation resistance between I/O terminals		RI-O	1000	-	-	MΩ	VI-O = 500 VDC, RoH ≤ 60 %
Turn-ON time		ton	-	-	0.5	ms	IF = 10 mA, RL = 200 Ω, VDD = 20 V (See note 2.)
Turn-OFF time		toff	-	-	0.5	ms	

Note: 2. Turn-ON and Turn-OFF Times



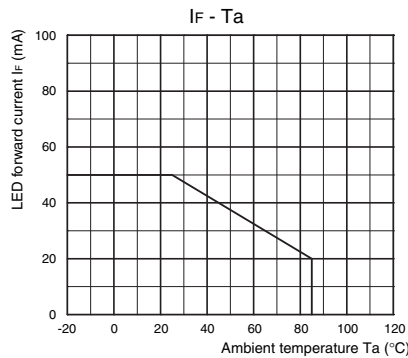
Recommended Operating Conditions

Use the G3VM under the following conditions so that the Relay will operate properly.

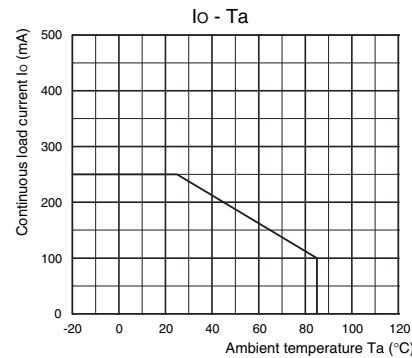
Item	Symbol	Minimum	Typical	Maximum	Unit
Load voltage (AC peak/DC)	V_{DD}	-	-	32	V
Operating LED forward current	I_F	10	-	30	mA
Continuous load current (AC peak/DC)	I_O	-	-	250	mA
Ambient operating temperature	T_a	25	-	60	°C

Engineering Data

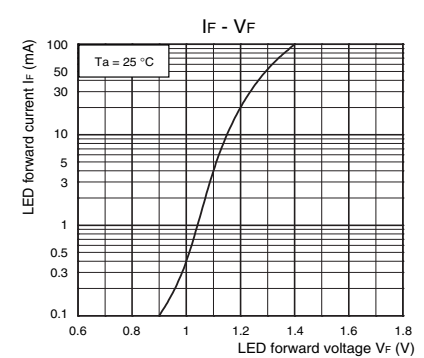
LED forward current vs. Ambient temperature



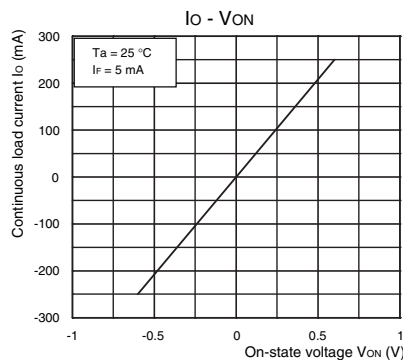
Continuous load current vs. Ambient temperature



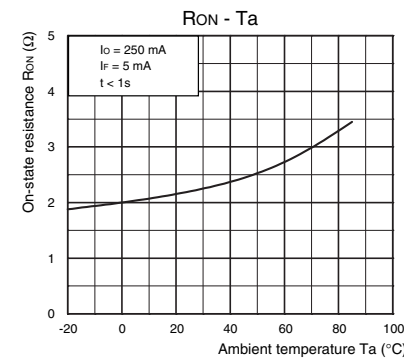
LED forward current vs. LED forward voltage



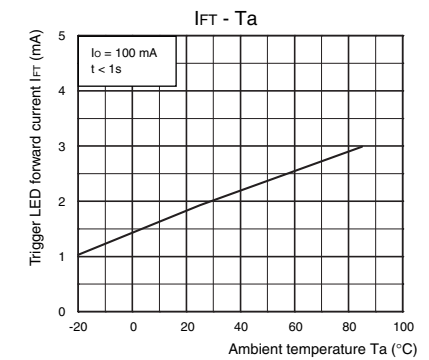
Continuous load current vs. On-state voltage



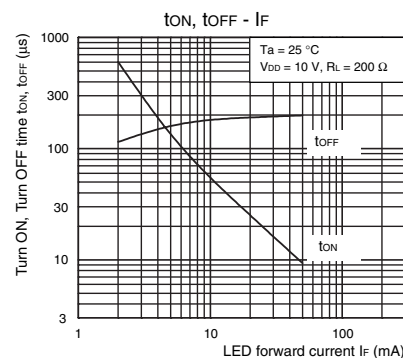
On-state resistance vs. Ambient temperature



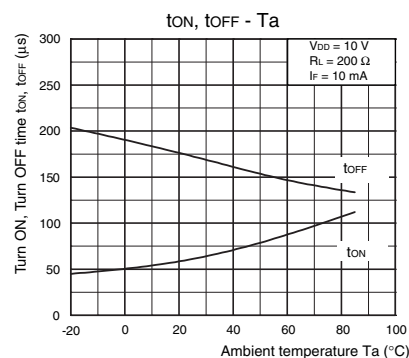
Trigger LED forward current vs. Ambient temperature



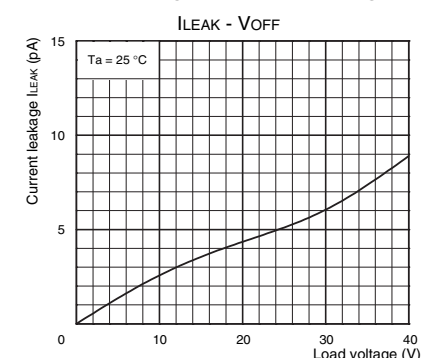
Turn ON, Turn OFF time vs. LED forward current



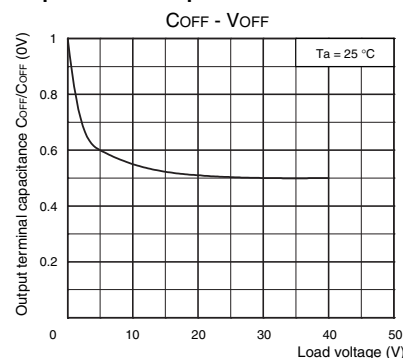
Turn ON, Turn OFF time vs. Ambient temperature



Current leakage vs. Load voltage



Output terminal capacitance vs. Load voltage

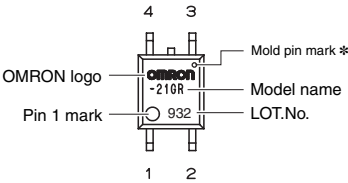


Safety Precautions

- Refer to "Common Precautions" for all G3VM models.

■ Appearance

SOP (Small Outline Package) SOP4



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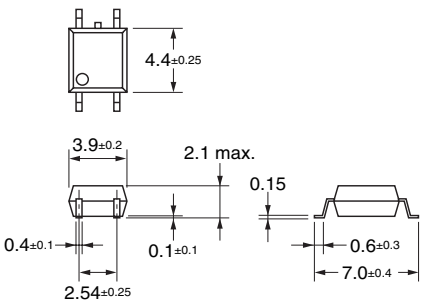
■ Dimensions

(Unit: mm)



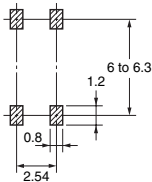
Surface-mounting Terminals

Weight: 0.1 g



Actual Mounting Pad Dimensions

(Recommended Value, TOP VIEW)



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- Application examples provided in this document are for reference only. In actual applications, confirm equipment functions and safety before using the product.
- Consult your OMRON representative before using the product under conditions which are not described in the manual or applying the product to nuclear control systems, railroad systems, aviation systems, vehicles, combustion systems, medical equipment, amusement machines, safety equipment, and other systems or equipment that may have a serious influence on lives and property if used improperly. Make sure that the ratings and performance characteristics of the product provide a margin of safety for the system or equipment, and be sure to provide the system or equipment with double safety mechanisms.

Note: Do not use this document to operate the Unit.

OMRON Corporation

ELECTRONIC AND MECHANICAL COMPONENTS COMPANY

Contact: www.omron.com/ecb

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